

**TEXTURE ANALYSIS OF METALS IN MICRO-VERSION :
THE ELECTRON BACKSCATTER DIFFRACTION TECHNIQUE**

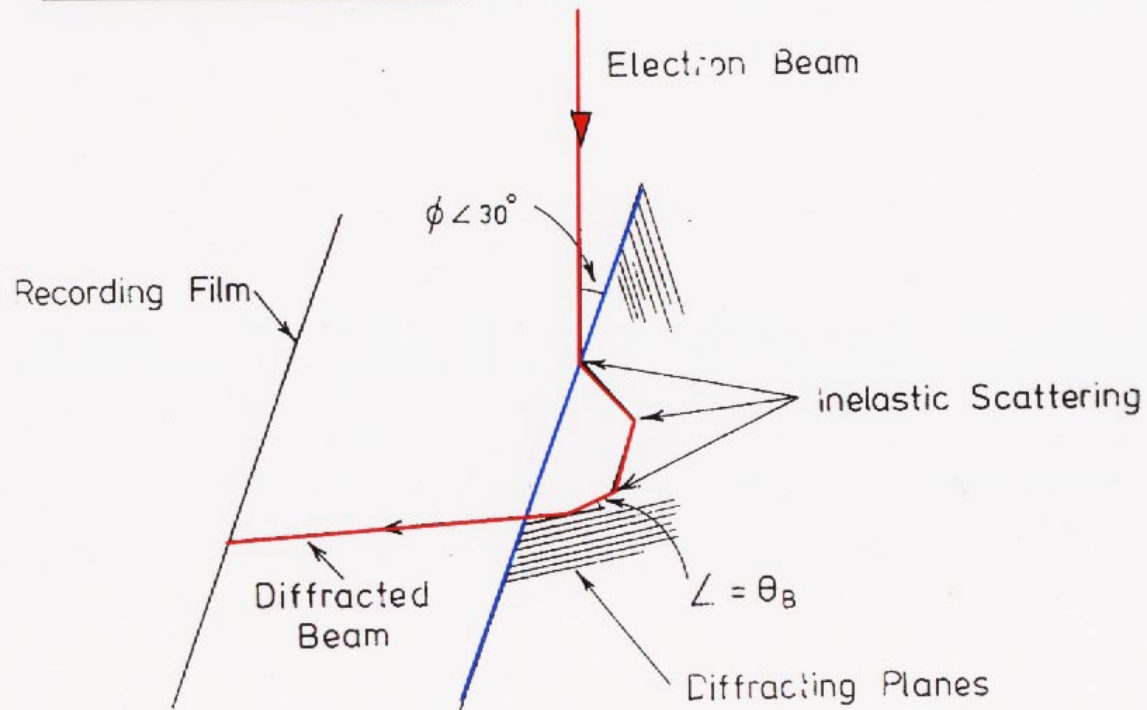
Leo Kestens

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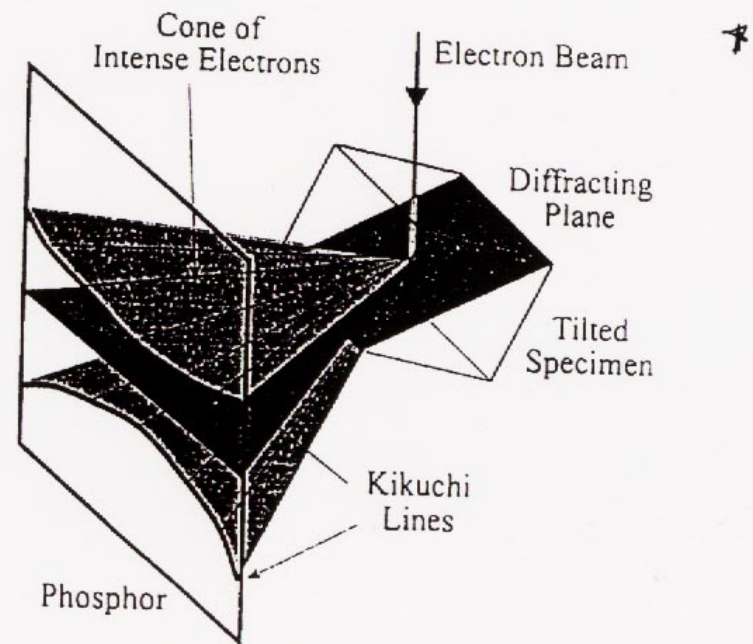


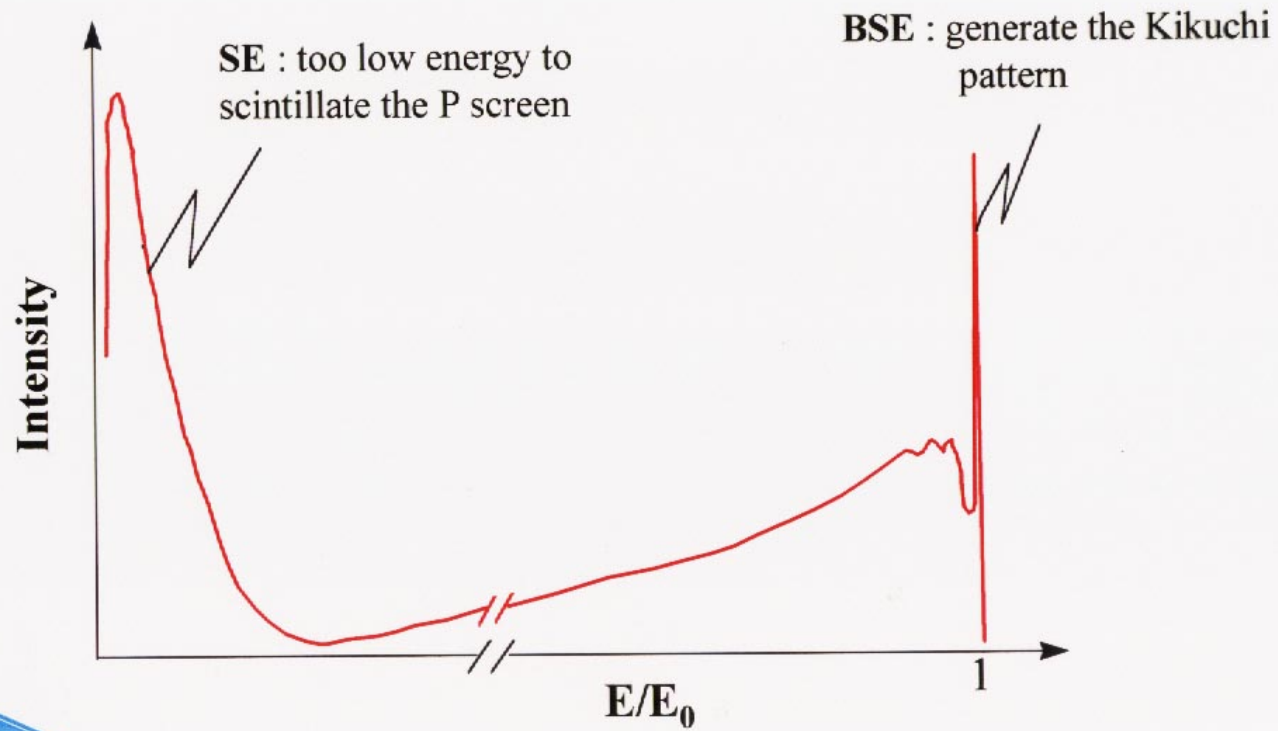
The Kikuchi Pattern

Electron BackScattering Diffraction (EBSD)



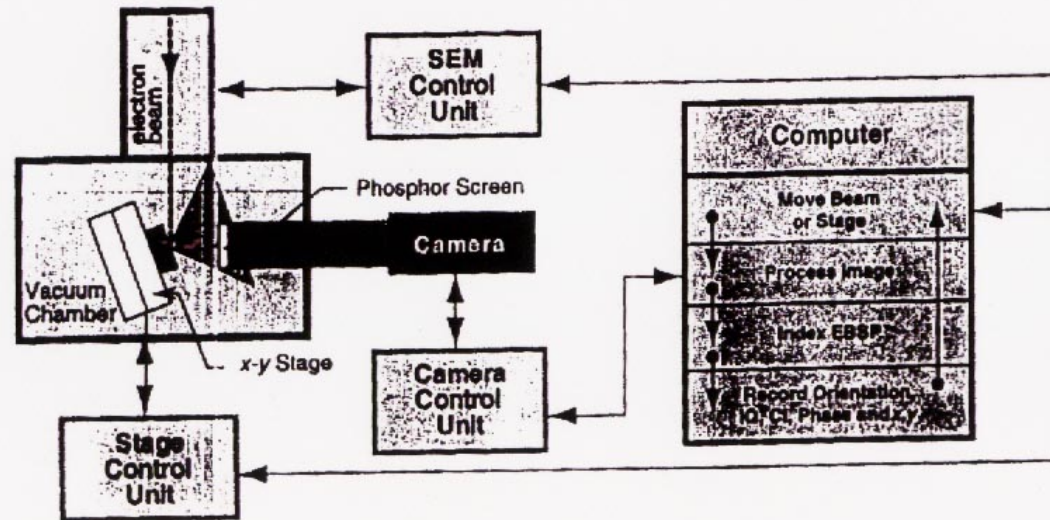
Kikuchi Lines = Image of crystal planes



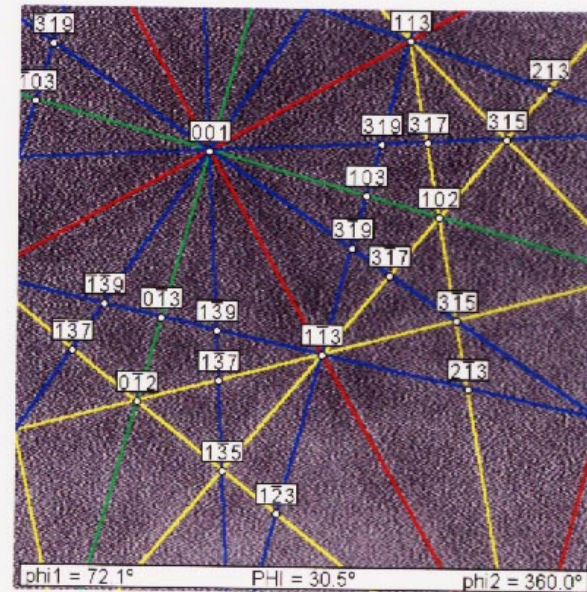
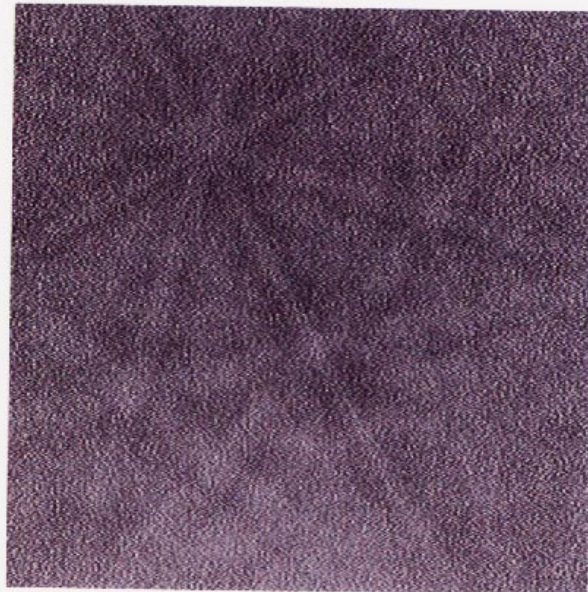


Orientation Imaging Microscopy

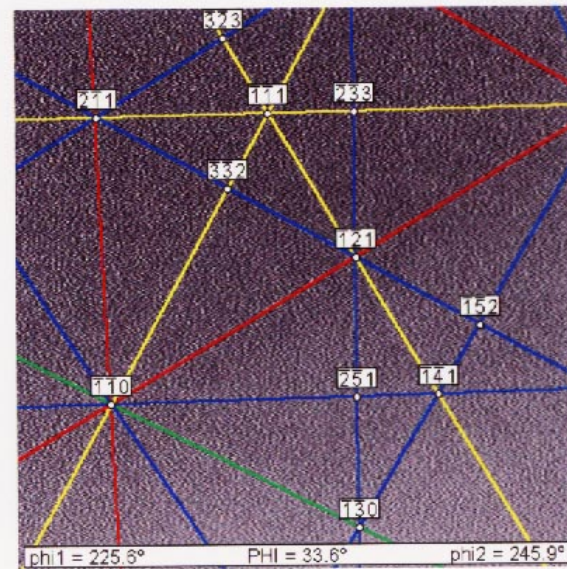
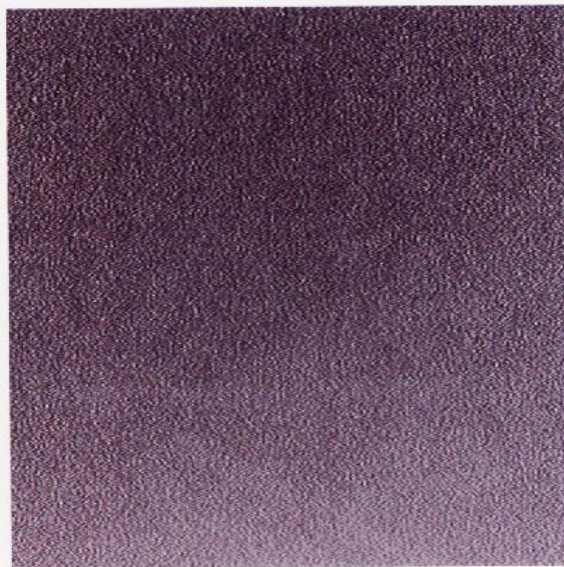
= Automated EBSD acquisition + post processing of data



Example of experimental EBSD pattern (BCC steel)



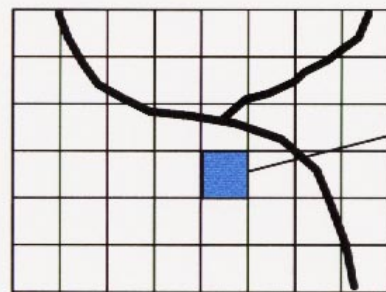
Example of experimental EBSD pattern
(residual austenite in TRIP steel)



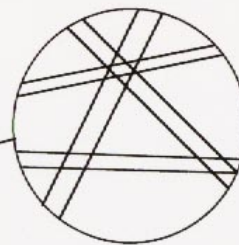
Orientation Imaging Microscopy (OIM)

= automated scanning version of *Electron Backscattering Diffraction (EBSD)*

(triple junction)

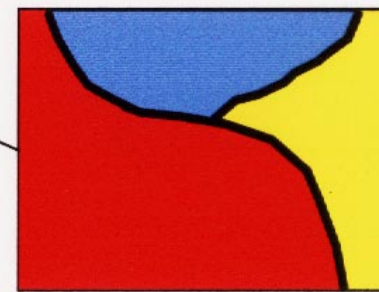


sample



EBSD

orientation
crystal structure



Image



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OIM image contains crystallographic information of sample surface

- crystal structure (bcc, fcc, hcp)
- crystal orientation
- crystal defects: dislocation substructure
residual stresses
grain boundaries



Image Quality Factor (IQ)

- Quantifies the band contrast of the EBSD pattern
- Depends on sample preparation and operation mode
- Also depends on material parameters :
crystal and structural defects !

Confidence Index (CI)

- Quantifies the reliability of the pattern indexing
- $0 < CI < 1$

- $CI = \frac{V_1 - V_2}{V_{total}}$ with V_1 = 1st solution
 V_2 = 2nd solution
 V_{tot} = total number
of solution



Operational mode of microscope for OIM

AV = 20 kV
Specimen tilt = 70deg
Spot size = 5-7
Dynamic Focus
(Specimen Tilt Correction)

Hardware parts of OIM system

Phosphor screen + camera
Image processor (frame integration, background correction)
Beam Controller
PC (>200 MHz)



Acquisition Time

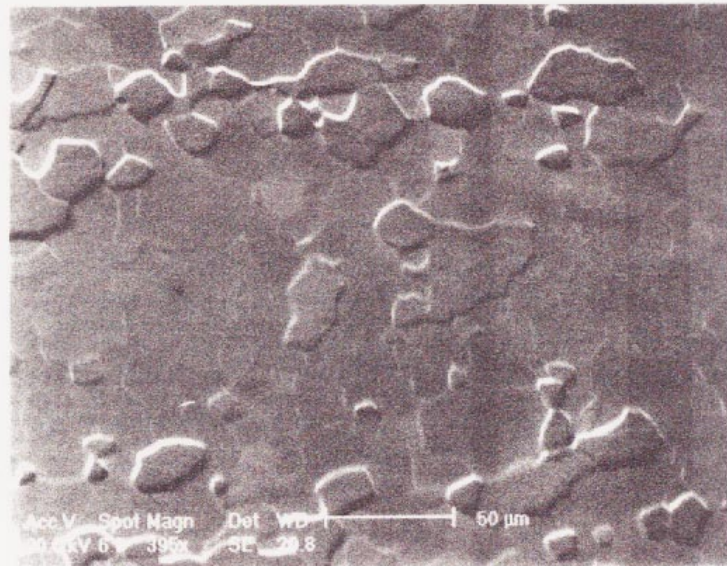
Quality of Diffraction Pattern
Sample preparation
Numbers of Integrated Frames
Crystal Structure(s) present in sample

E.g.: Steel sample (fully recrystallized, single phase)
 $\approx 0.5 - 1.0$ s per pixel
Typical scan ≈ 40.000 pixels \longrightarrow 6 - 12 h



ULC steel (CEIT) : 90% cold rolled + annealed

(ferrite single phase polycrystal structure)



SE image on ESEM XL30



OIM image of same sample site

Greyscale defined by image quality factor of diffraction pattern

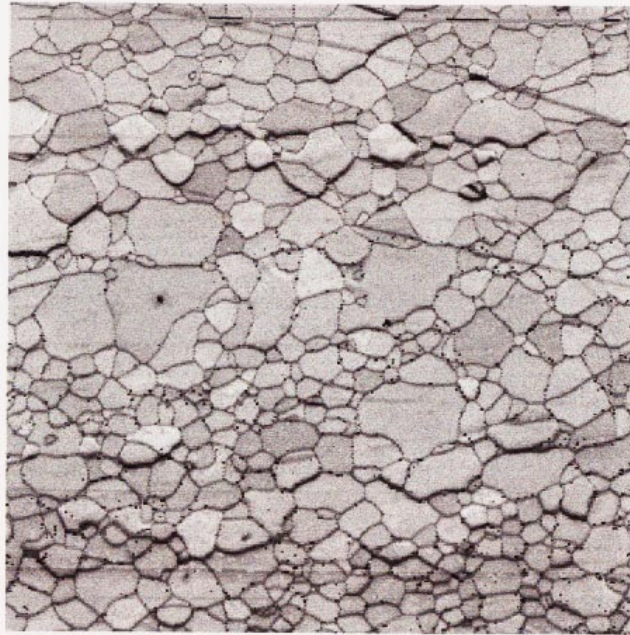


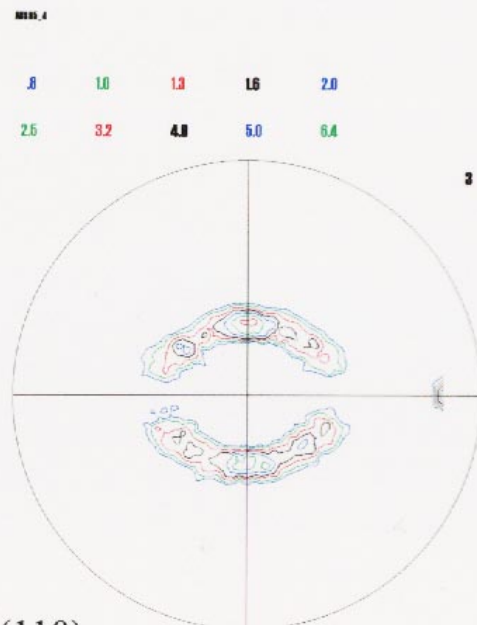
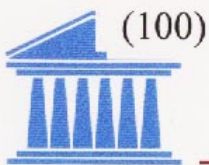
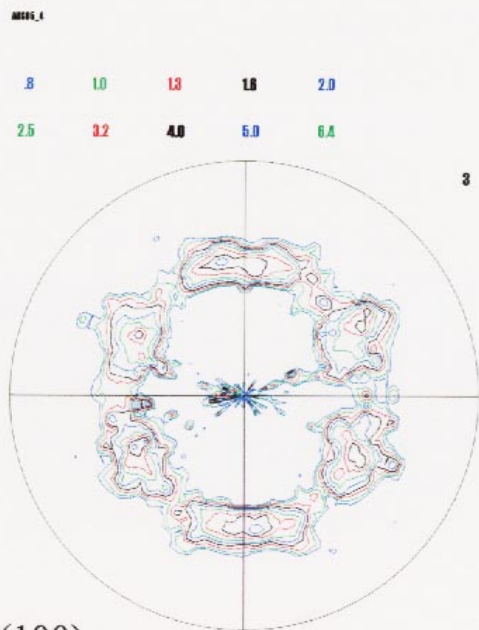
Image Quality
1.74 - 174.20



70 μm

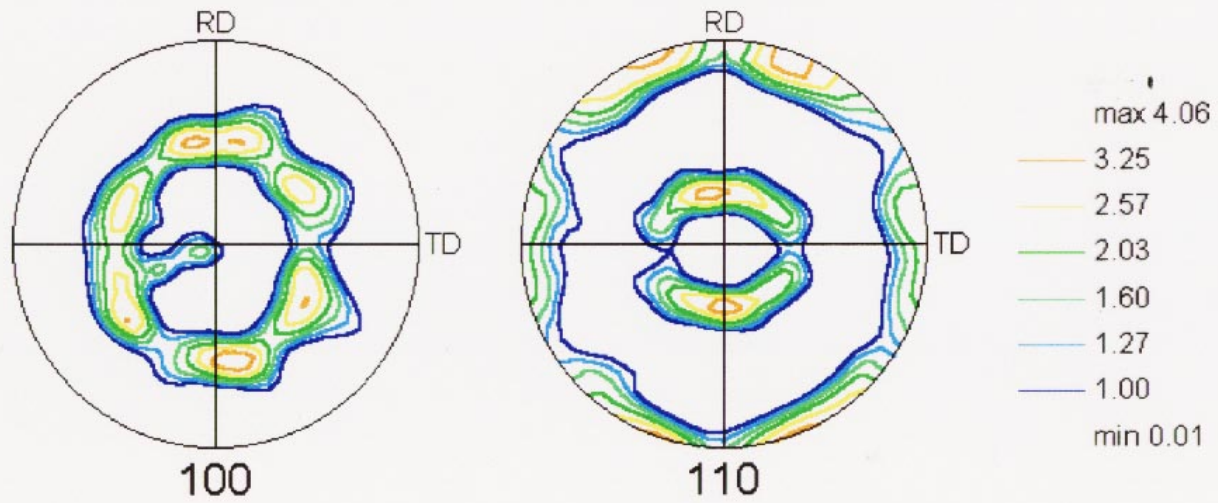
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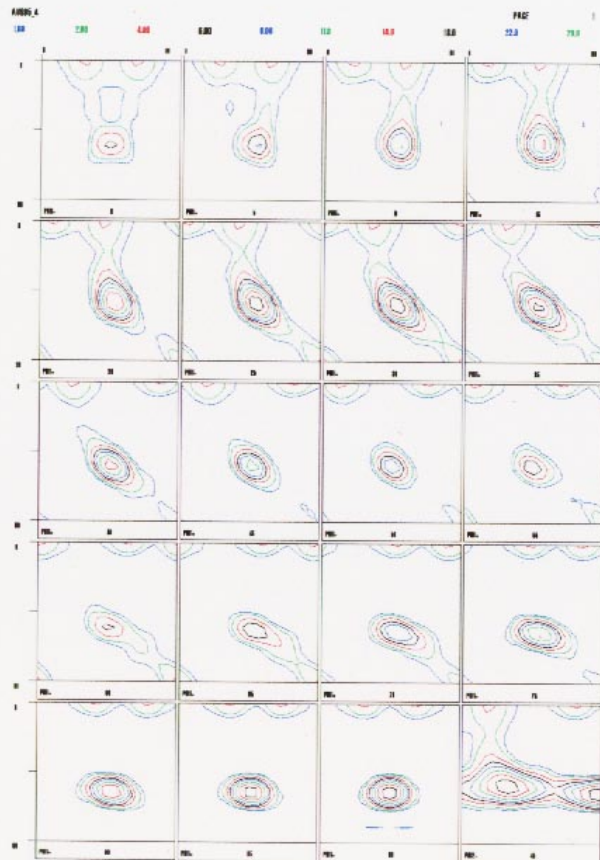
Pole figures obtained by X-ray diffraction



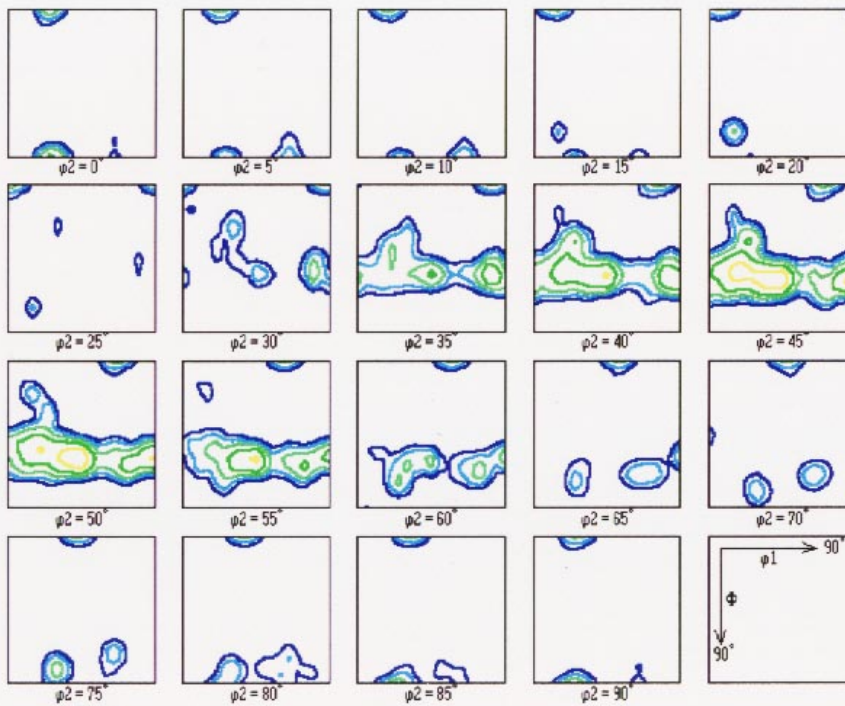
(110)

Pole figures obtained by OIM





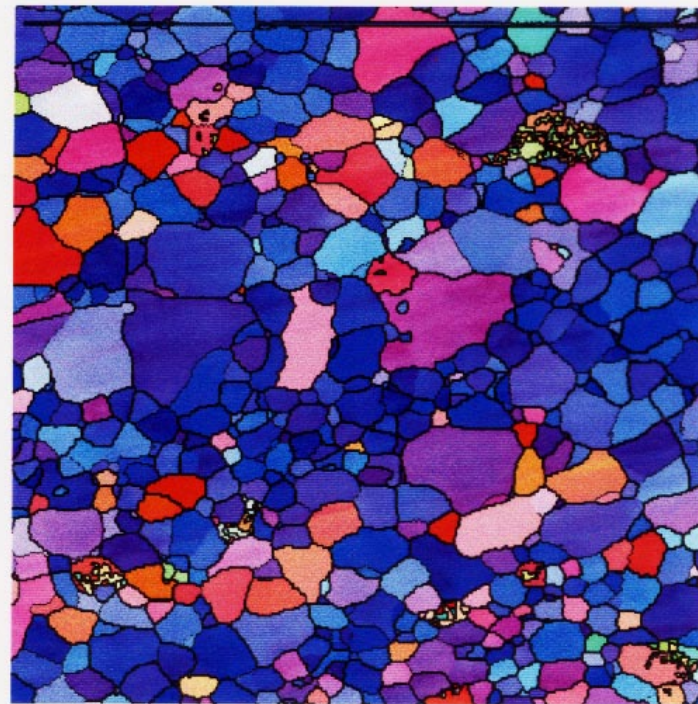
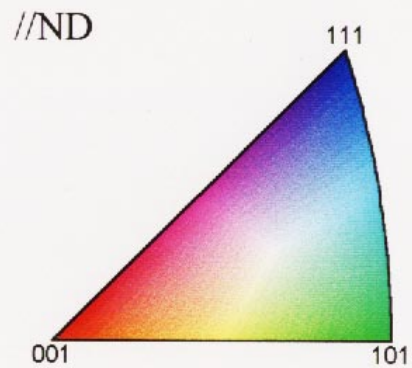
**ODF obtained from X-ray
diffraction measurement**



**ODF obtained from
OIM measurement
as calculated by
TSL software**

OIM image of same sample site

Colors defined by orientation of crystal direction // ND



Boundary levels: 5.0° 15.0°

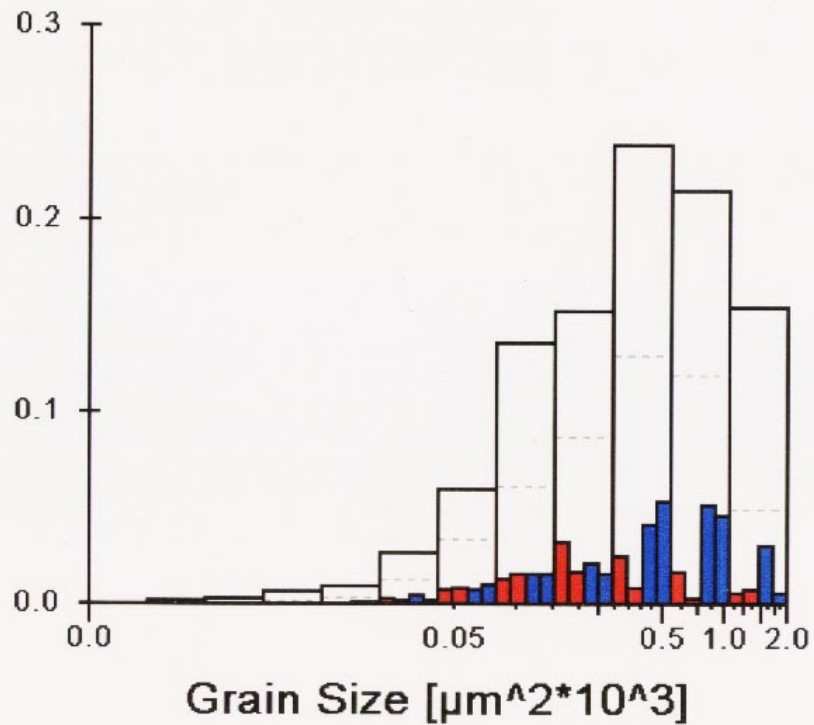
70 μm



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Grain Size Distribution

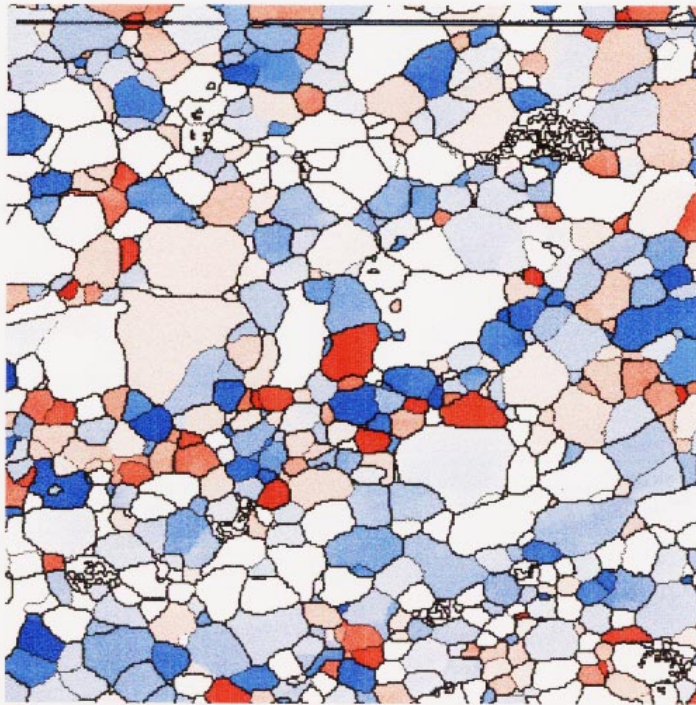
Area Fraction



blue = $\{111\}\langle 211\rangle$

red = $\{111\}\langle 110\rangle$

Presence of Specific Orientations in the Microstructure



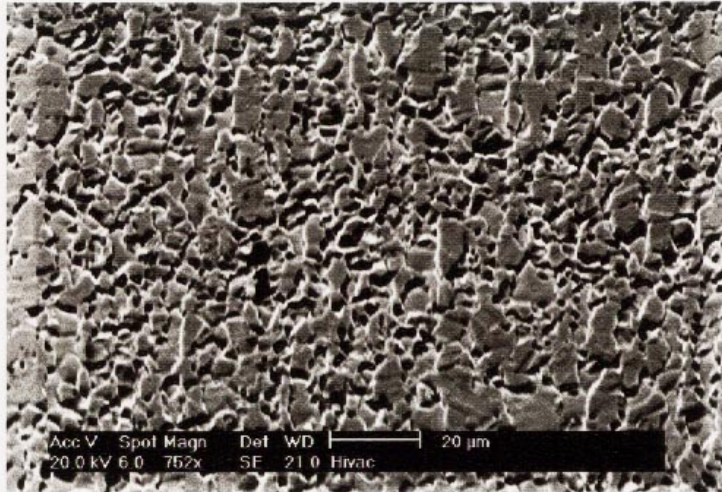
Boundary levels: 5.0° 15.0°

70 μm

blue = $\{111\}\langle 211\rangle$
(43% volume fraction)

red = $\{111\}\langle 110\rangle$
(27% volume fraction)

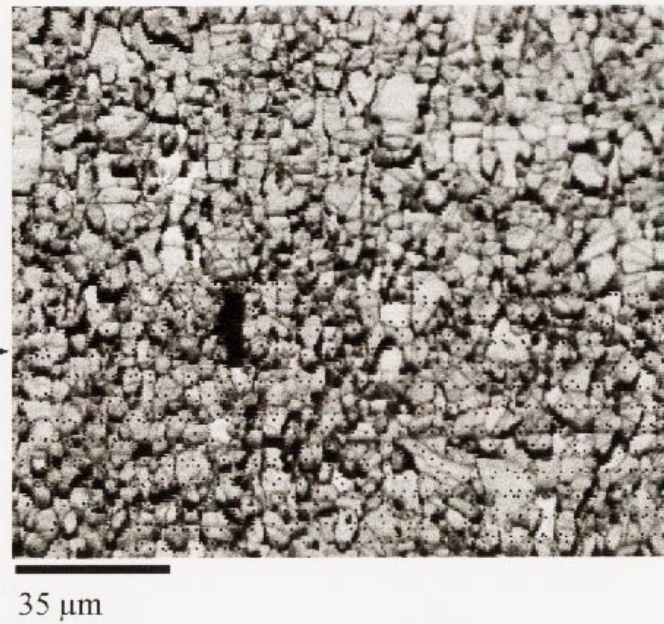
Duplex Stainless Steel (Ferrite + Austenite)



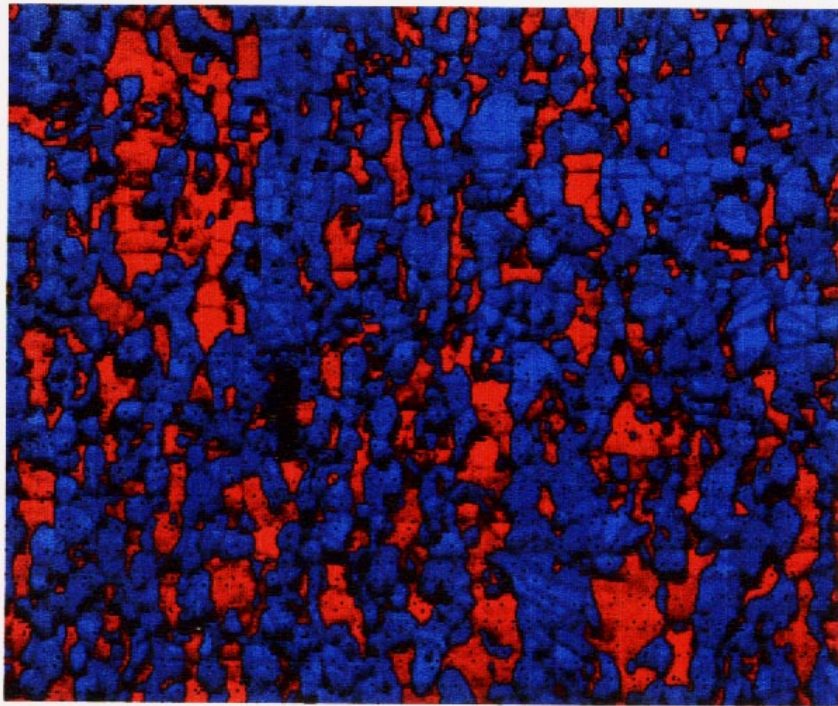
OIM image
Greyscale = Image Quality
factor

OIM image

This orientation imaging microscopy (OIM) image shows the same duplex stainless steel microstructure as the SEM image. The greyscale intensity represents the image quality factor, which is used to distinguish between the different crystallographic orientations of the ferrite and austenite phases. A scale bar at the bottom left indicates a length of 35 micrometers.



Phase Distribution in Duplex Stainless Steel



35 μm

blue = austenite
(71% volume fraction)

red = ferrite
(29% volume fraction)

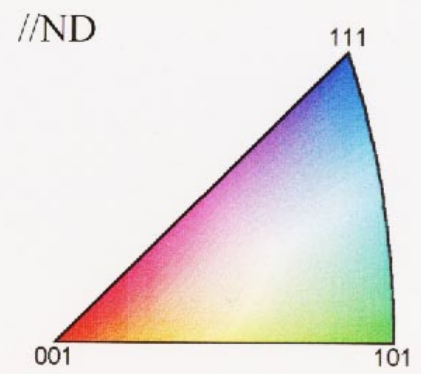
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Texture of Ferrite Phase

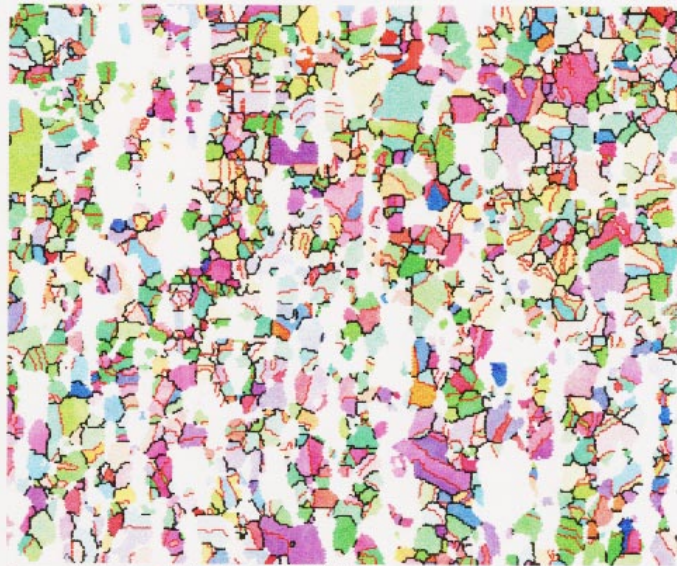


35 μm

- $5^\circ < \omega < 15^\circ$
- $15^\circ < \omega < 180^\circ$



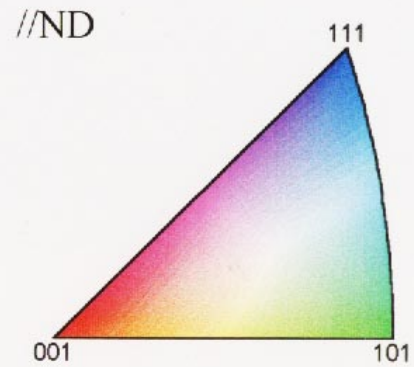
Texture of Austenite Phase



35 μm

Boundary levels: 5.0° 15.0°

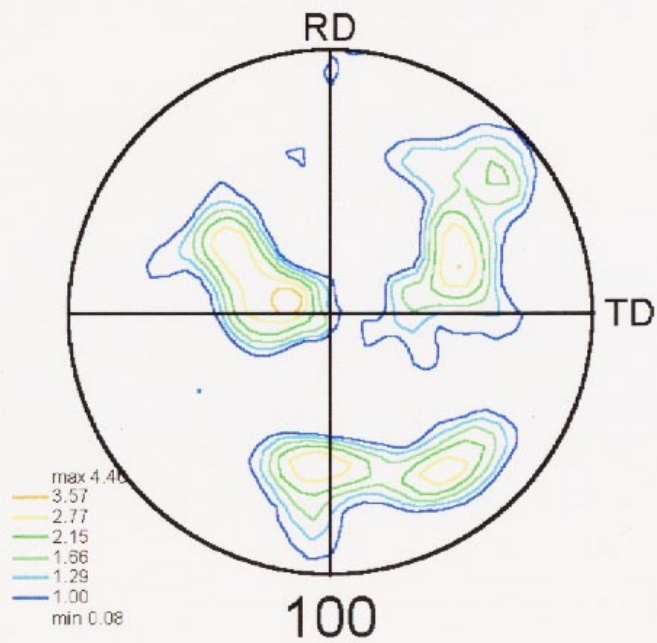
- $5^\circ < \omega < 15^\circ$
- $15^\circ < \omega < 180^\circ$
- twin misorientation



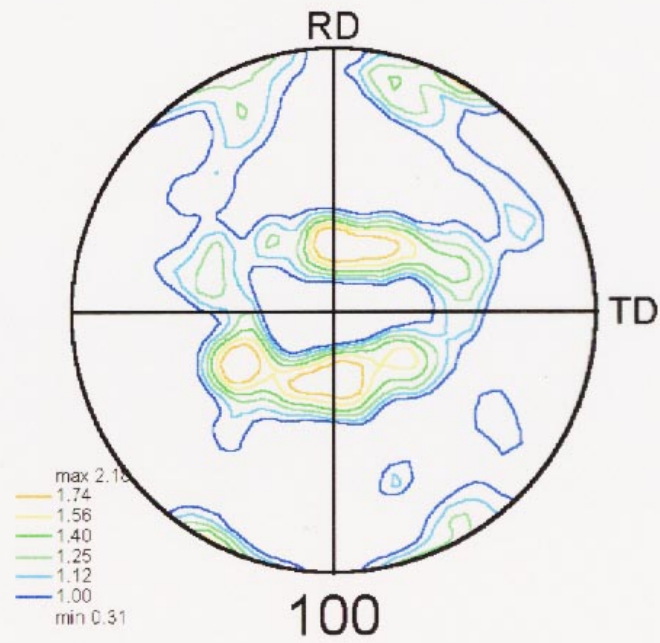
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Comparison of Austenite and Ferrite Texture

Ferrite



Austenite

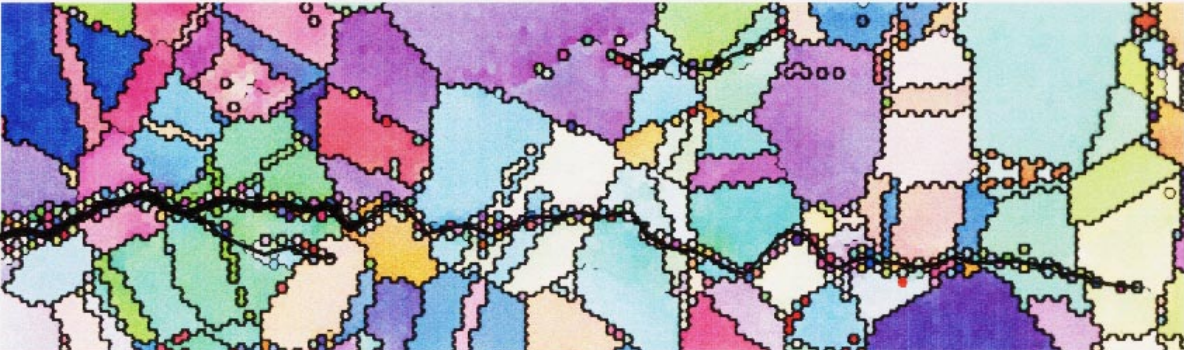


Microcrack in Aluminium

(courtesy: TexSem Ltd.)



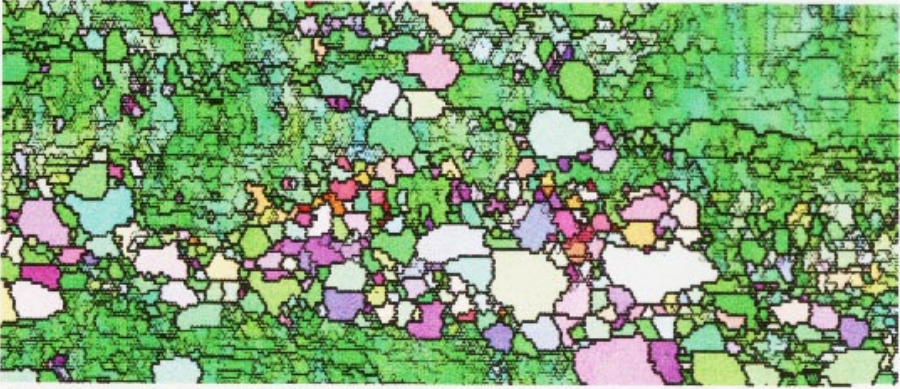
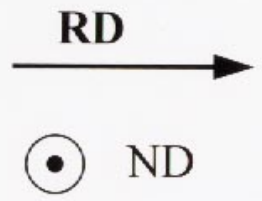
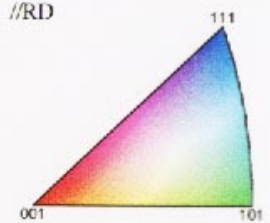
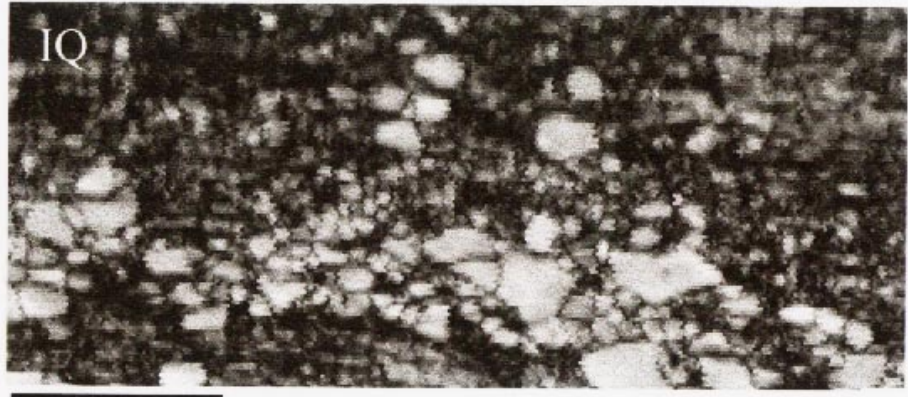
10.00 μm = 5 steps



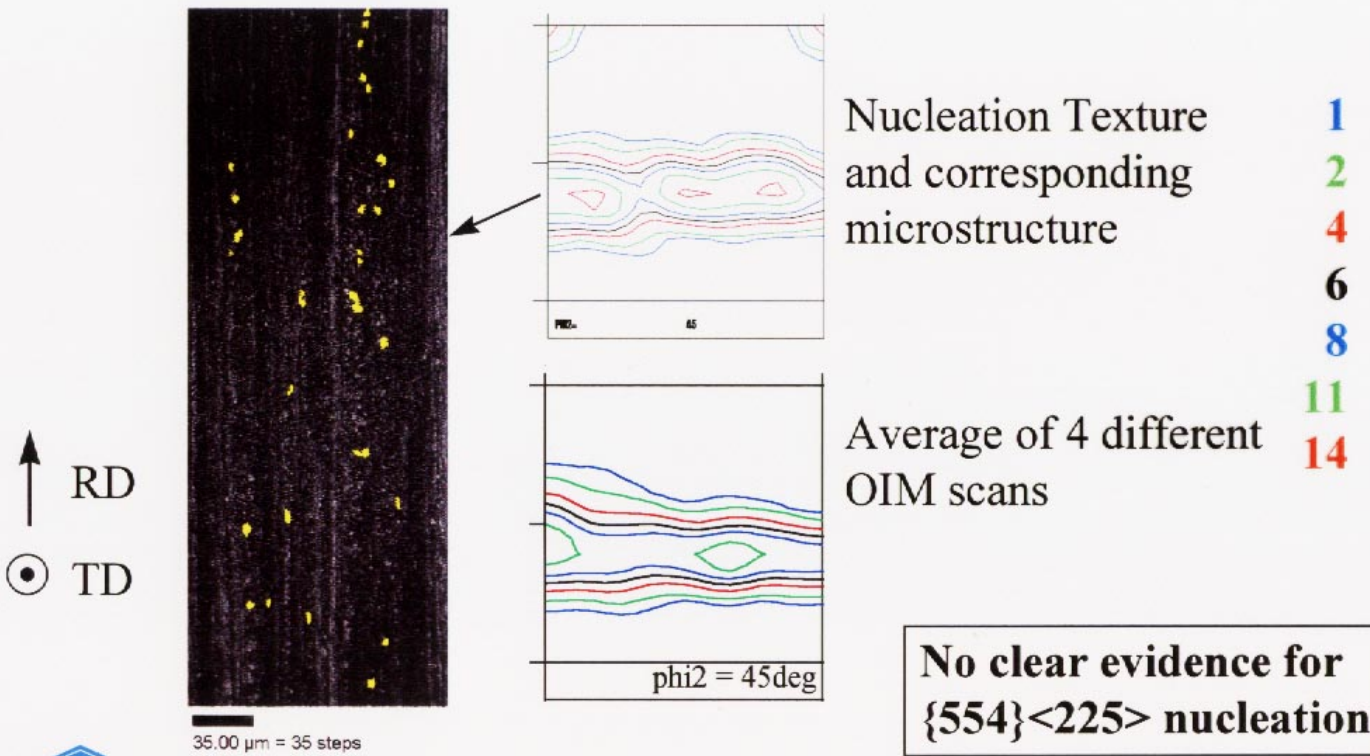
10.00 μm = 5 steps

f GENT

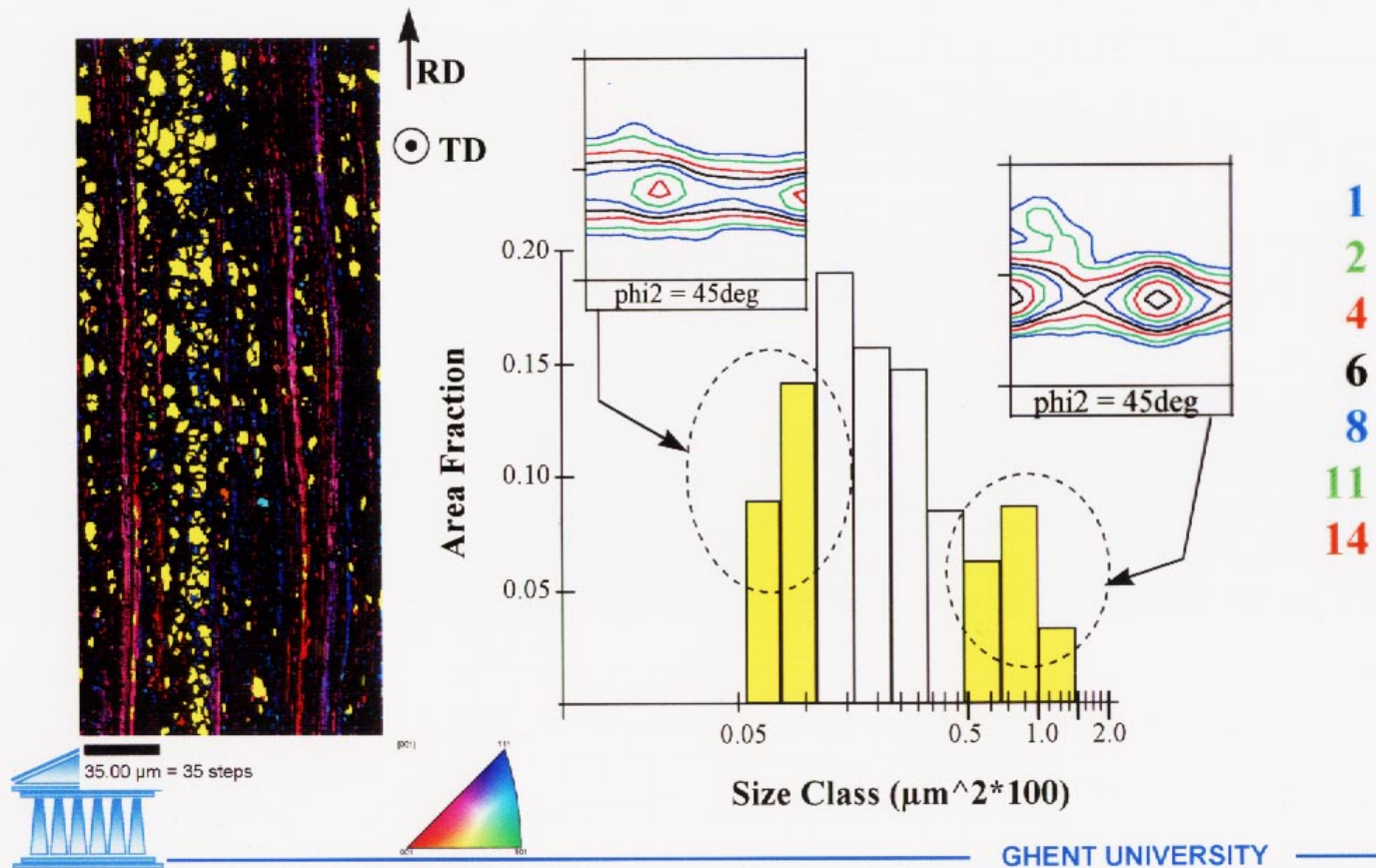
Partially recrystallized steel sample



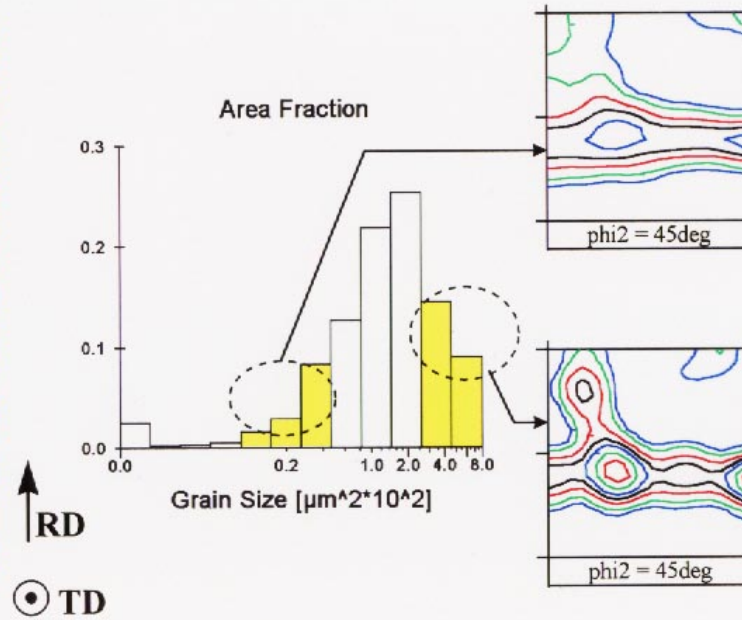
OIM scan of Early Nucleation Structure



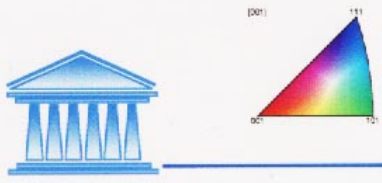
Intermediate Recrystallization Stage



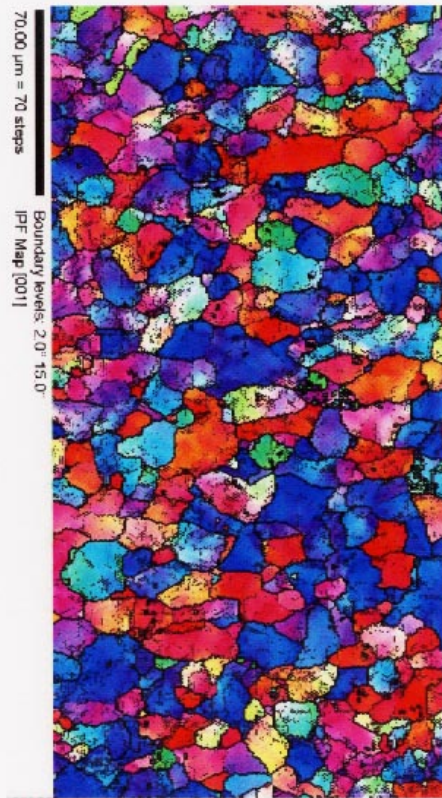
OIM scan of Fully Recrystallized Structure Quenched from 720°C



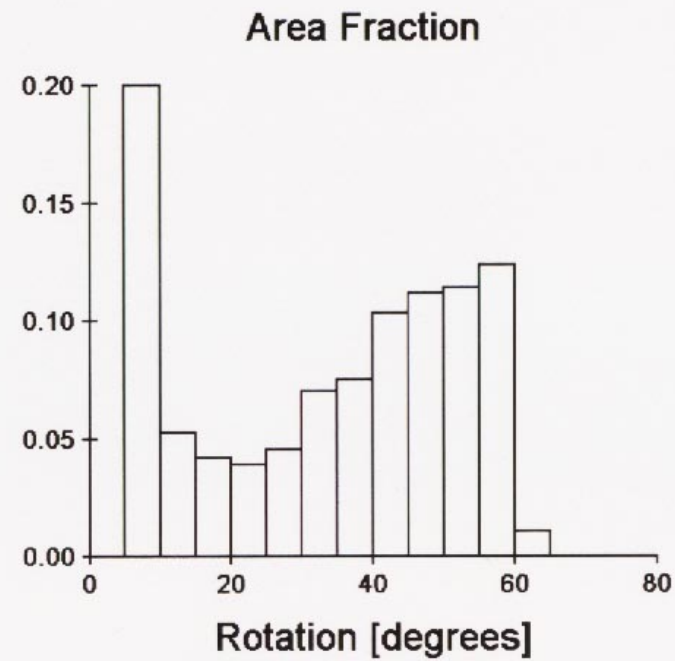
- 1
- 2
- 4
- 6
- 8
- 11
- 14



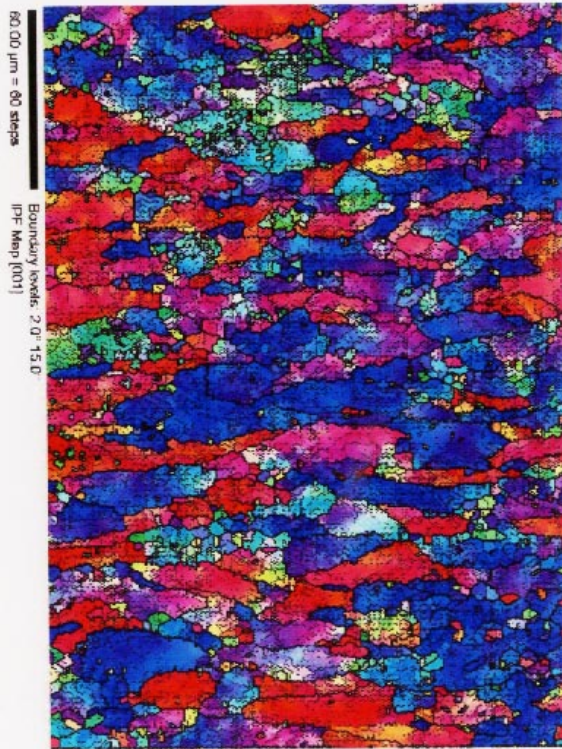
Deformation (sub-)structure : ¹⁰45% cold rolled steel sheet



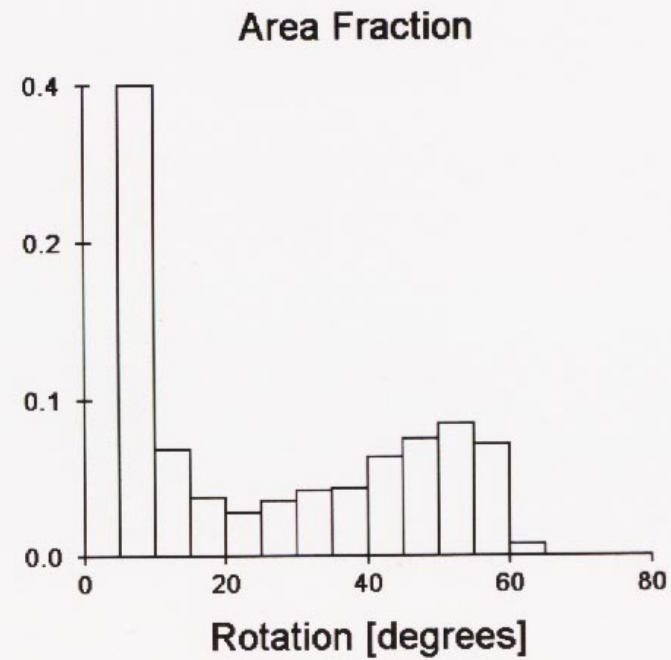
→ RD



Deformation (sub-)structure : 45% cold rolled steel sheet

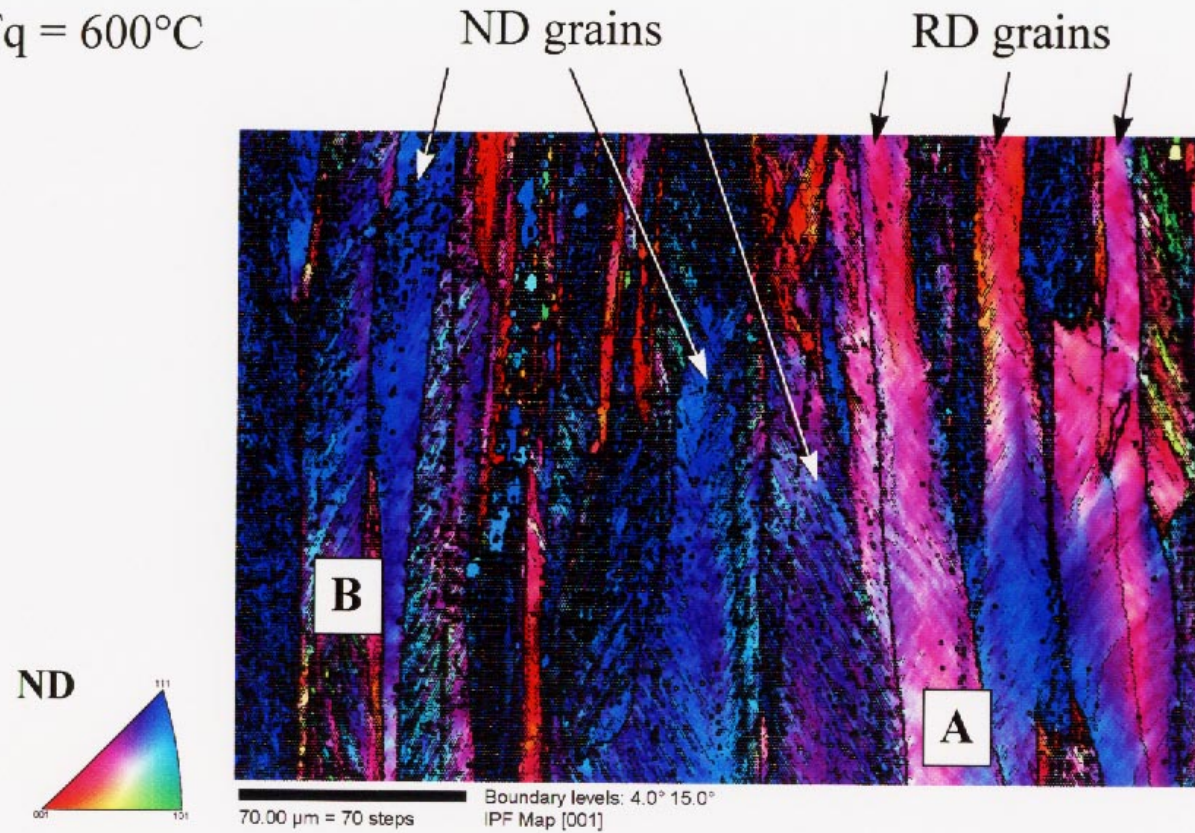


→ RD

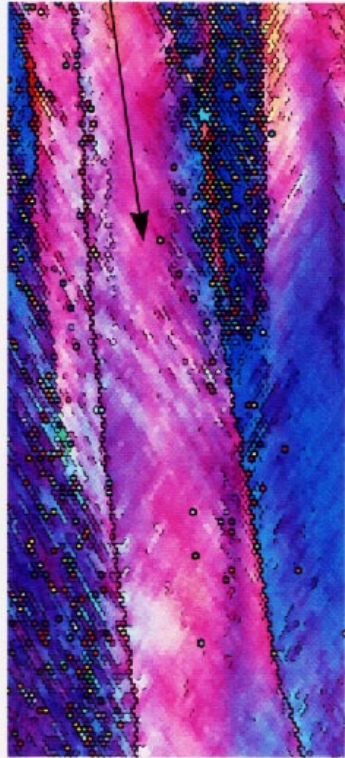


Observation of in-grain shear bands in 70% CR + recovered structure

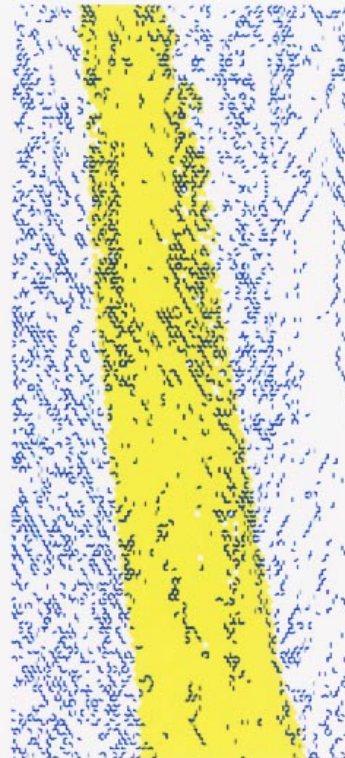
$T_q = 600^\circ\text{C}$



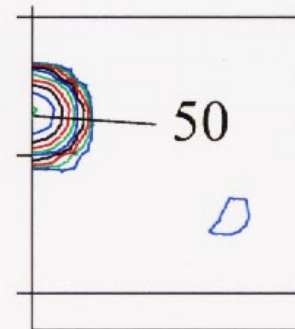
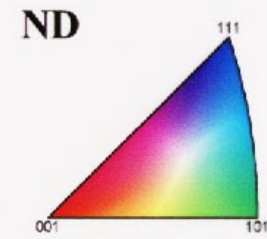
Grain A



15.00 μm = 15 steps



15.00 μm = 15 steps

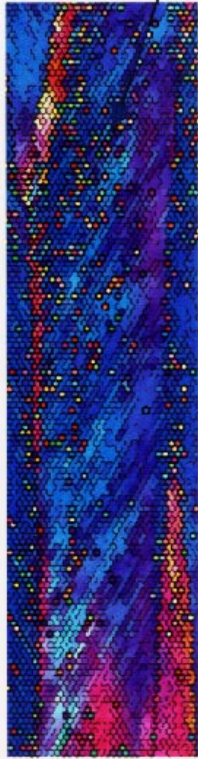


Blue GB = $\langle 110 \rangle 4^\circ$; $\Delta = 2.5^\circ$

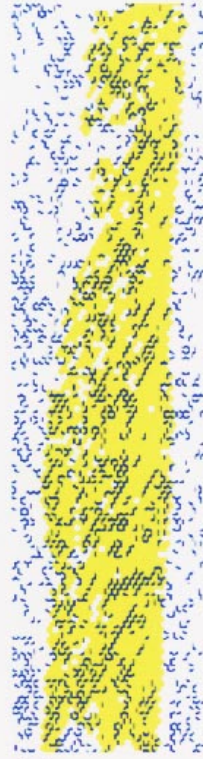


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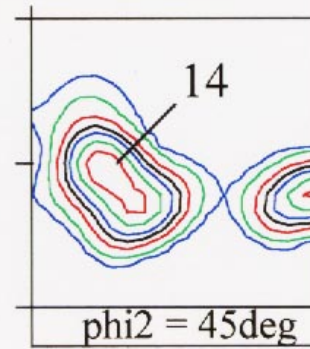
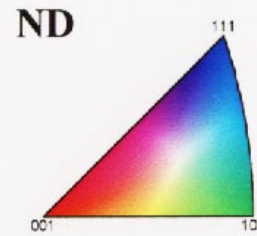
Grain B



5.00 μm = 5 steps



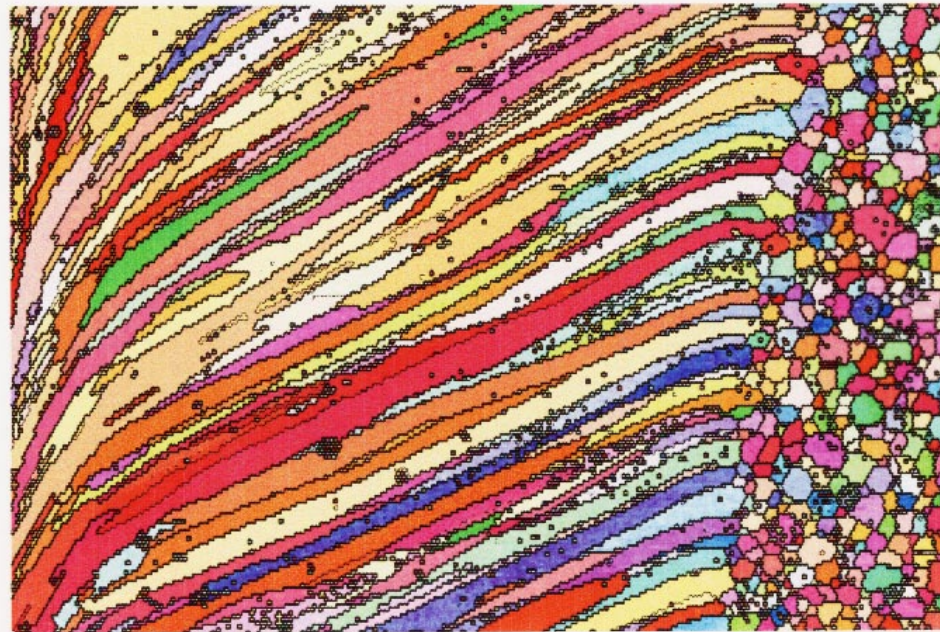
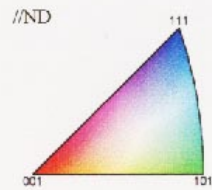
5.00 μm = 5 steps



Blue GBs = $\langle 110 \rangle 6\text{deg}$
 $\Delta = 6\text{deg}$

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Electron Beam Weld in Beryllium



1250.0 μm = 50 steps
Boundary levels: 5.0° 15.0°
IPF Map [001]

(courtesy: TexSem Ltd.)

Conclusion

- Originally the *Electron BackScattering Diffraction* technique was mainly used for local orientation studies in texture related research.
- Orientation Imaging Microscopy* has fully developed into a new branch of microscopy.
- The main advantages of this technique are:
 - ☺ allows to produce microscope images based on crystallographic contrast
 - ☺ wide variety of materials
 - ☺ relatively friendly operation mode.
- Thus, potential of scanning electron microscopy extend into a field which was hitherto mainly accessible by X-ray techniques.



ESEM studiedag

ORIENTATION IMAGING MICROSCOPY

Leo Kestens

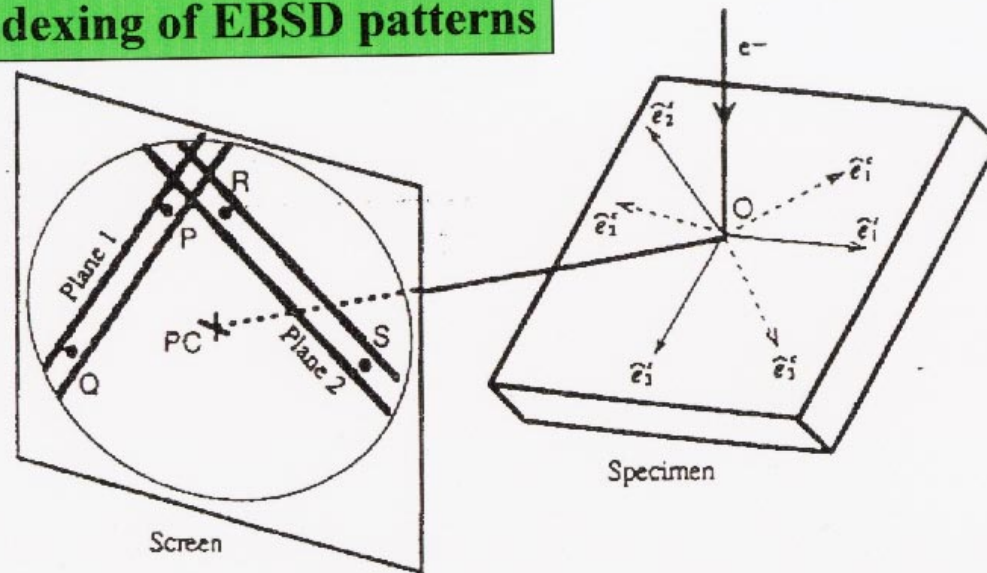
*Laboratorium voor Algemene Metallurgie, Siderurgie
en Fysische Metaalkunde, Universiteit Gent*

14/10/1998



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Indexing of EBSD patterns

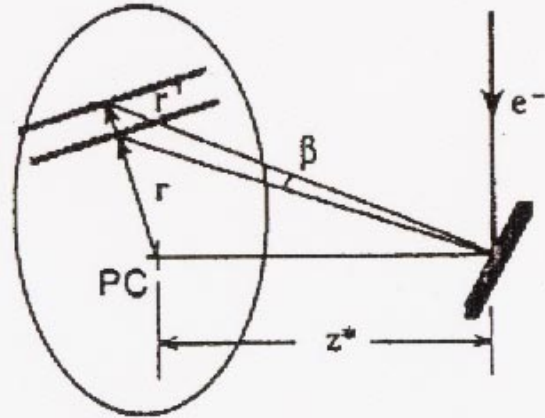


Interplanar angle between planes: $\cos \gamma = |\bar{n}_1 \cdot \bar{n}_2|$

$$\bar{n}_1 = \frac{\overline{OP} \times \overline{OQ}}{|\overline{OP} \times \overline{OQ}|} \quad \bar{n}_2 = \frac{\overline{OR} \times \overline{OS}}{|\overline{OR} \times \overline{OS}|}$$

$$\cos \gamma = \frac{h_1 h_2 + k_1 k_2 + l_1 l_2}{(h_1^2 + k_1^2 + l_1^2)^{1/2} (h_2^2 + k_2^2 + l_2^2)^{1/2}}$$

Bandwidth angle β



$$\beta = \tan^{-1}\left(\frac{r'}{z^*}\right) - \tan^{-1}\left(\frac{r}{z^*}\right)$$

$$\beta = 2 \sin^{-1}\left(\frac{\lambda}{2d_{hkl}}\right)$$

Values for γ and β are compared with theoretical values



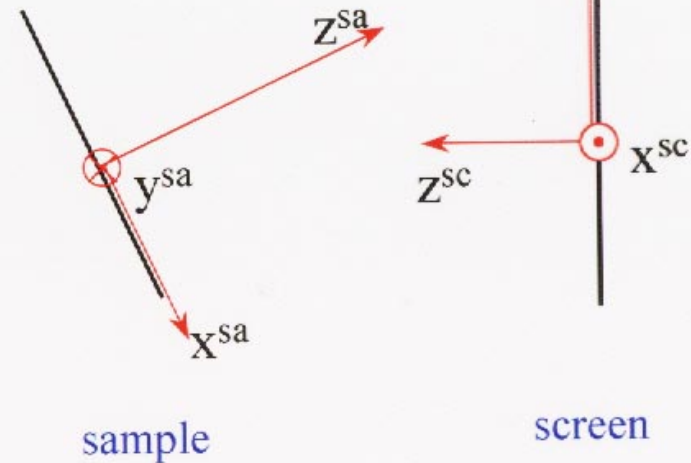
selection is made on basis of closest match



Calculation of Crystal Orientation

Following reference systems are involved:

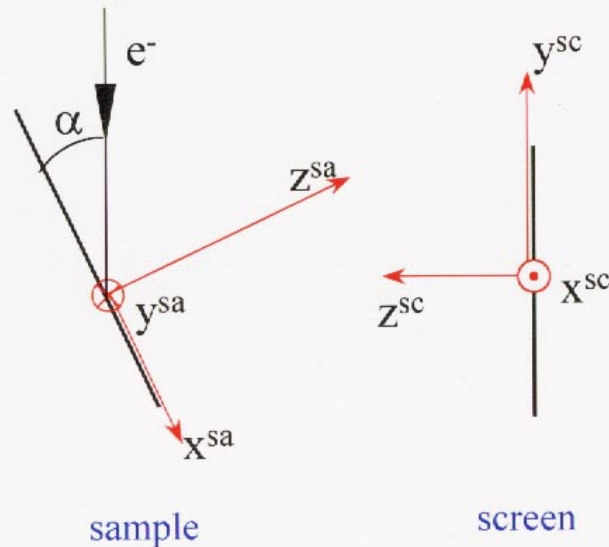
1. Crystal reference system: \bar{e}_i^c
($\langle 100 \rangle$ axes for a cubic crystal)
2. Sample reference system: \bar{e}_i^{sa}
(RD, TD, ND axes for rolled sheet)
3. Screen reference system: \bar{e}_i^{sc}
4. Pattern reference system \bar{e}_i^p



Transformation from pattern to screen coordinates:

$$g'_{ij} = \bar{e}_i^p \cdot \bar{e}_j^{sc}$$

Transformation from screen to sample coordinates: $g''_{ij} = \bar{e}_i^{sc} \cdot \bar{e}_j^{sa}$



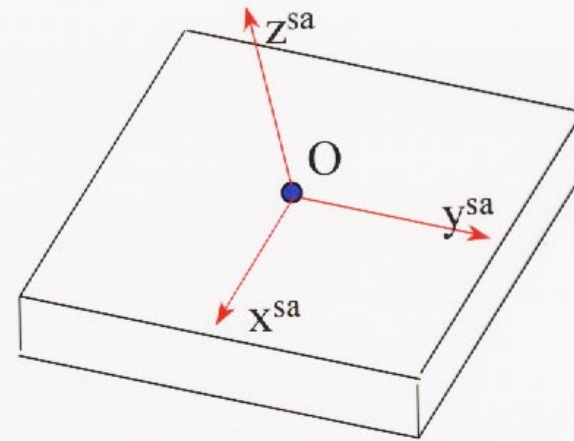
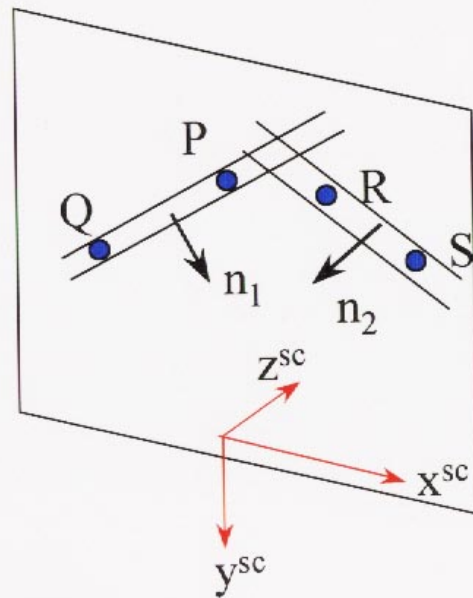
$$\bar{e}_1^{sc} = -\bar{e}_2^{sa}$$

$$\bar{e}_2^{sc} = \bar{e}_2^{sa} \sin \alpha - \bar{e}_3^{sa} \cos \alpha$$

$$\bar{e}_3^{sc} = -(\bar{e}_1^{sa} \sin \alpha + \bar{e}_3^{sa} \cos \alpha)$$

Construction of pattern reference system

base: \bar{e}_i^p



$$\bar{n}_1 = \frac{\overline{OP} \times \overline{OQ}}{|\overline{OP} \times \overline{OQ}|}$$

$$\bar{e}_1^p = \bar{n}_1$$

$$\bar{e}_2^p = \bar{n}_1 \times \bar{n}_2$$

$$\bar{n}_2 = \frac{\overline{OR} \times \overline{OS}}{|\overline{OR} \times \overline{OS}|}$$

$$\bar{e}_3^p = \bar{e}_1^p \times \bar{e}_2^p$$



Transformation from crystal to pattern coordinates:

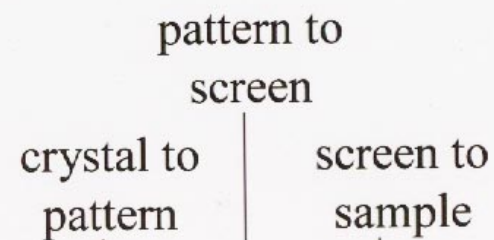
\bar{e}_i^p can be expressed in terms of crystal coordinates

$$\bar{e}_1^p = \frac{(hkl)_1}{|(hkl)_1|}$$

$$\bar{e}_2^p = \frac{(hkl)_1}{|(hkl)_1|} \times \frac{(hkl)_2}{|(hkl)_2|}$$

$$\bar{e}_3^p = \bar{e}_1^p \times \bar{e}_2^p$$

$$g'''_{ij} = \bar{e}_i^c \cdot \bar{e}_j^p$$



Orientation matrix:

$$g_{ij} = g'''_{ik} \quad g'_{kl} \quad g''_{lj}$$

